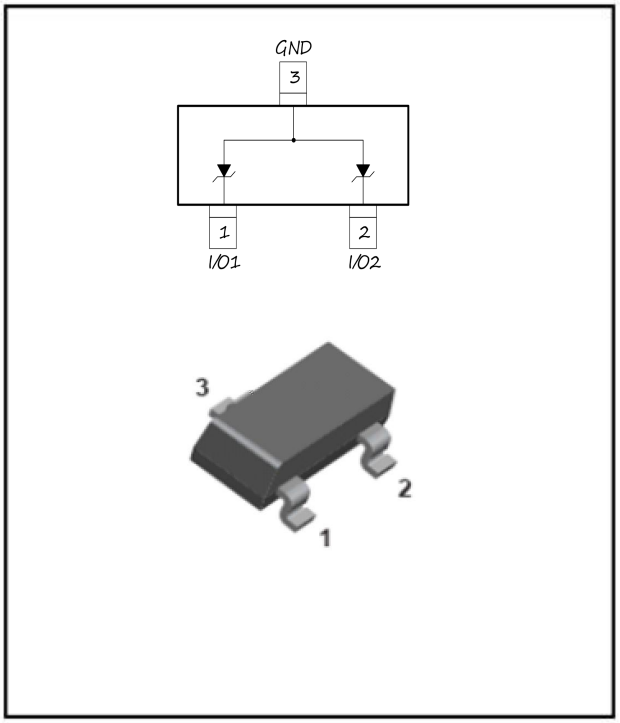
2-L e, U -d ec a , T a e V a e S e

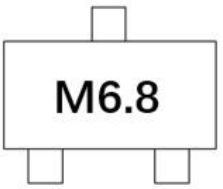


Fea e

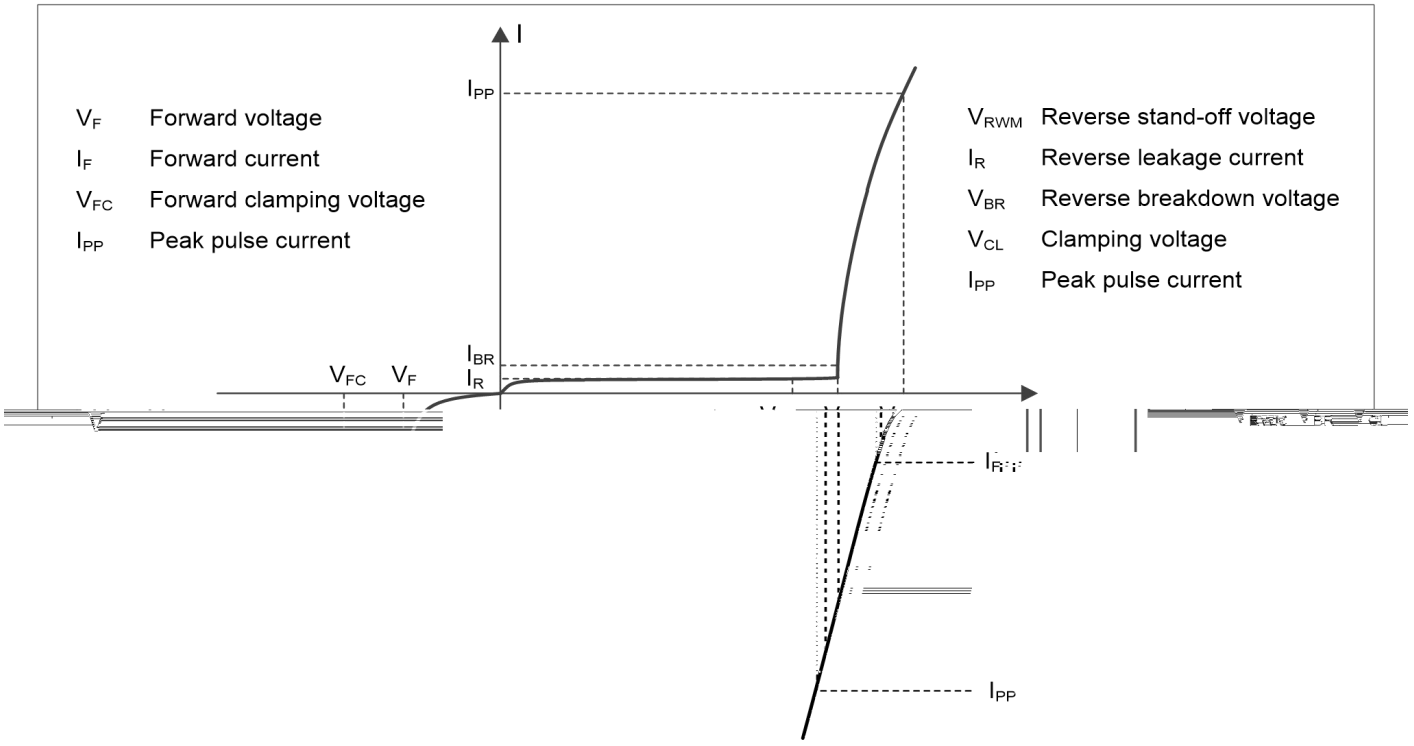
((
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A ca

Mec a ca Da a



De e ec ca c a ac e c



Ma Ra

PARAMETER	SYMBOL	LIMITS	UNIT
(			
(			

E ec ca C a ac e c （Ta=25℃ U e e ec ed）

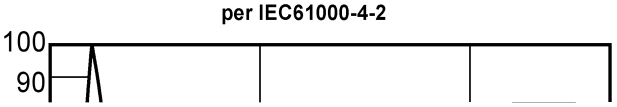
PARAMETER	S b	UNIT	C d	M	T	Ma
2)						

(
(

O de l a (E a e)

PREFERED P/N	PACKING CODE	UNIT WEIGHT( )	MINIMUM PACKAGE(c)	INNER BOX QUANTITY(c)	OUTER CARTON QUANTITY(c)	DELIVERY MODE

Fig 2:Contact discharge current waveform
per IEC61000-4-2



Peak pulse current

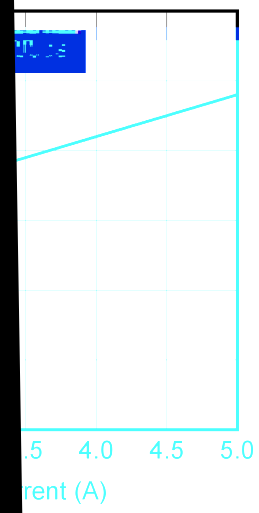
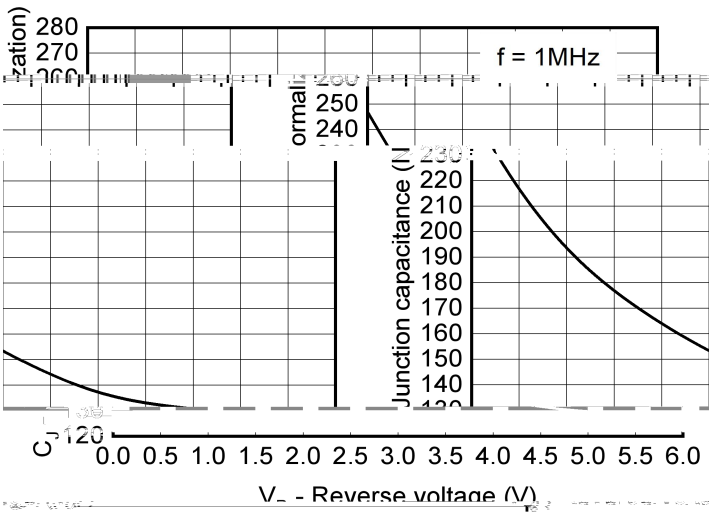
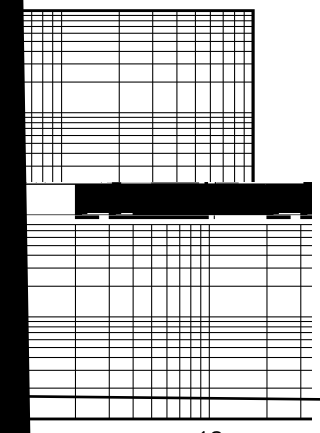


Fig4：Capacitance vs. Reverse voltage



power vs. Pulse time



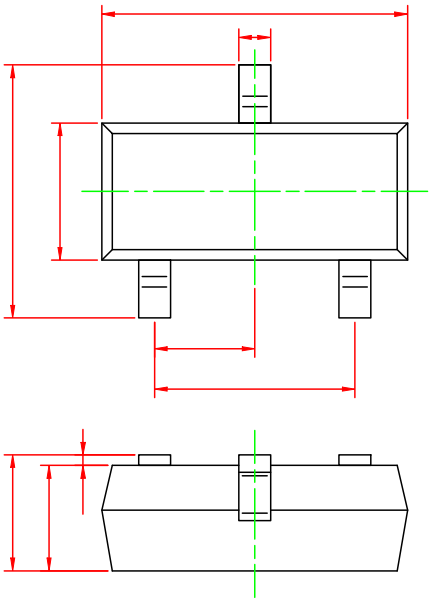
100

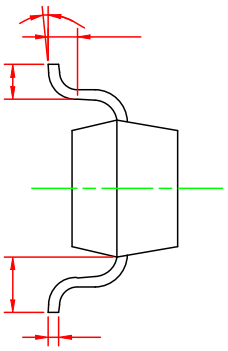
e (μs)

10

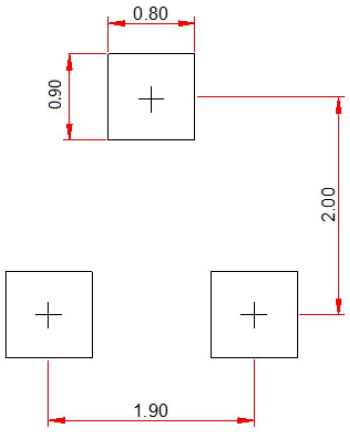
Pulse tir

O e D e





S de F



Notes:
This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.